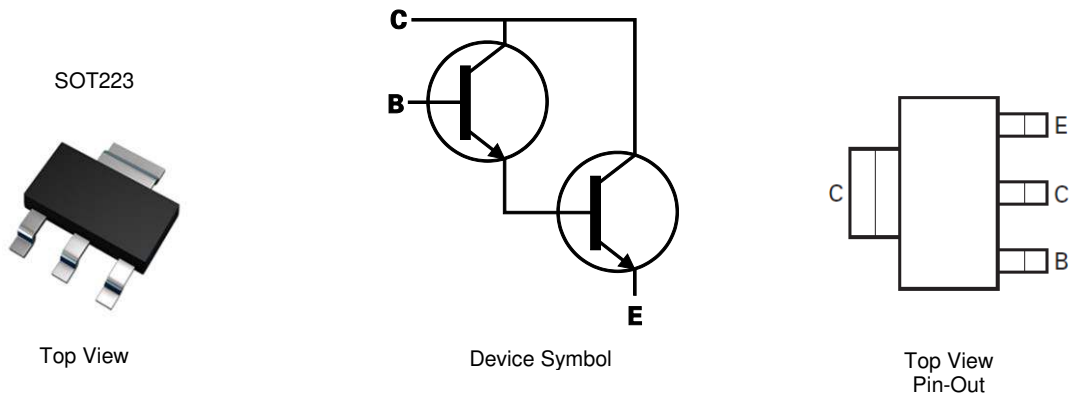


Features

- $BV_{CEO} > 140V$
- $BV_{CBO} > 160V$
- $I_C = 2A$ High Continuous Current
- NPN Darlington With Gain $> 10k$
- Guaranteed h_{FE} Specified up to 1A
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **An Automotive-Compliant Part is Available Under Separate Datasheet ([FZT600BQ](#))**

Mechanical Data

- Case: SOT223 (Type DN)
- Case Material: Molded Plastic. "Green" Molding Compound; UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 ③
- Weight: 0.112 grams (Approximate)

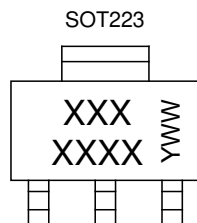


Ordering Information (Note 5)

Product	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
FZT600TA	AEC-Q101	FZT600	7	12	1000
FZT600BTA	AEC-Q101	FZT600B	7	12	1000

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, see <http://www.diodes.com/products/packages.html>.

Marking Information



XXX XXXX = Product Type Marking Code
 YWW = Date Code Marking
 Y or \bar{Y} = Last Digit of Year (ex: 8= 2018)
 WW or \bar{WW} = Week Code (01~53)

Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	160	V
Collector-Emitter Voltage	V _{CEO}	140	V
Emitter-Base Voltage	V _{EBO}	10	V
Continuous Collector Current	I _C	2	A
Peak Pulse Current	I _{CM}	4	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

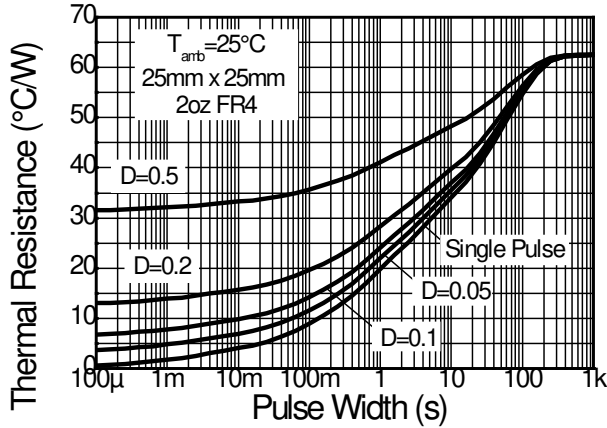
Characteristic	Symbol	Value	Unit
Power Dissipation	P _D	(Note 5)	3.0
		(Note 6)	2.0
		(Note 7)	1.6
		(Note 8)	1.2
Thermal Resistance, Junction to Ambient	R _{θJA}	(Note 5)	41.7
		(Note 6)	62.5
		(Note 7)	78.1
		(Note 8)	104
Thermal Resistance Junction to Lead	R _{θJL}	12.9	
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

ESD Ratings (Note 10)

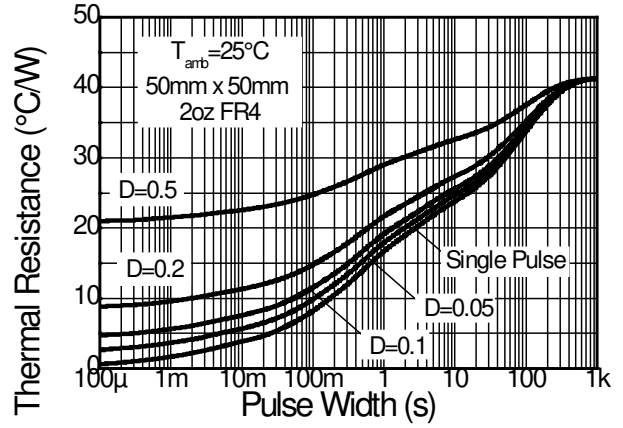
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge—Human Body Model	ESD HBM	2000	V	2
Electrostatic Discharge—Machine Model	ESD MM	200	V	B

- Notes:
5. For a device mounted with the collector lead on 50mm × 50mm 2oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.
 6. Same as Note 6, except the device is mounted on 25mm × 25mm 2oz copper.
 7. Same as Note 6, except the device is mounted on 25mm × 25mm 1oz copper.
 8. Same as Note 6, except the device is mounted on minimum recommended pad layout.
 9. Thermal resistance from junction to solder-point (at the end of the collector lead).
 10. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

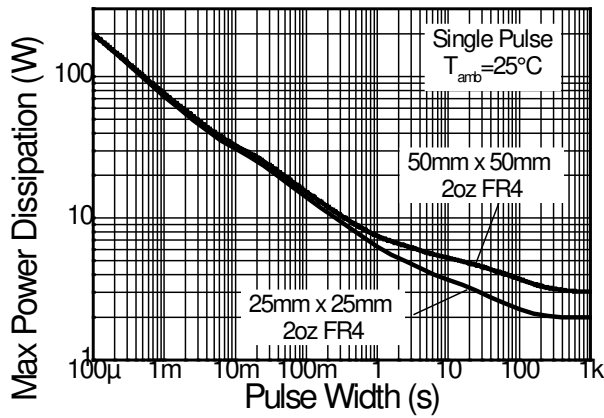
Thermal Characteristics and Derating Information



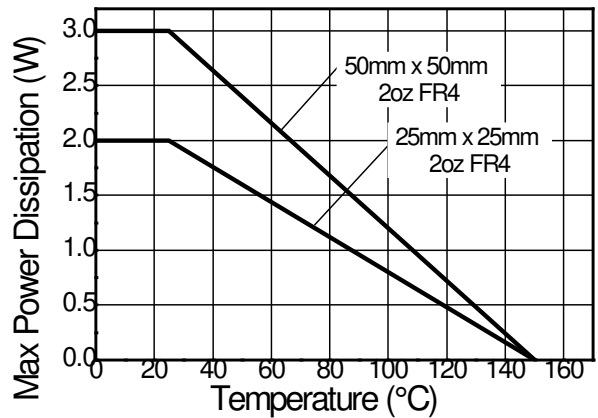
Transient Thermal Impedance



Transient Thermal Impedance



Pulse Power Dissipation



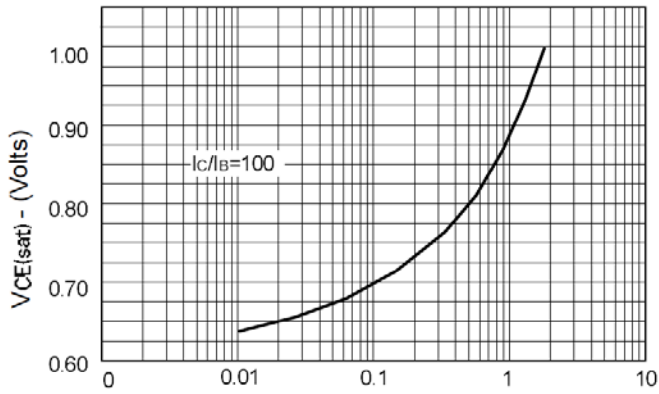
Derating Curve

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition	
Collector-Base Breakdown Voltage	BV _{CBO}	160	—	—	V	I _C = 100μA	
Collector-Emitter Breakdown Voltage (Note 12)	BV _{CEO}	140	—	—	V	I _C = 10mA	
Emitter-Base Breakdown Voltage	BV _{EBO}	10	—	—	V	I _E = 100μA	
Collector-Base Cut-Off Current	I _{CBO}	—	—	0.01 10	μA μA	V _{CB} = 140V V _{CB} = 140V, T _A = +100°C	
Collector-Emitter Cut-Off Current	I _{CES}	-	—	10	μA	V _{CE} = 140V	
Emitter Cut-Off Current	I _{EBO}	-	—	0.1	μA	V _{EB} = 8V	
DC Current Gain (Note 12)	h _{FE}	Group A (FZT600)		1000 2000 1000	— — —	100,000 — —	I _C = 50mA, V _{CE} = 10V I _C = 500mA, V _{CE} = 10V I _C = 1A, V _{CE} = 10V
		Group B (FZT600B)		5000 10,000 5000	10,000 20,000 10,000	— 100,000 —	I _C = 50mA, V _{CE} = 10V I _C = 500mA, V _{CE} = 10V I _C = 1A, V _{CE} = 10V
Collector-Emitter Saturation Voltage (Note 12)	V _{CE(sat)}	—	0.75 0.85	1.1 1.2	V	I _C = 500mA, I _B = 5mA I _C = 1A, I _B = 10mA	
Base-Emitter Saturation Voltage (Note 12)	V _{BE(sat)}	—	1.7	1.9	V	I _C = 1A, I _B = 10mA	
Base-Emitter Turn-On Voltage (Note 12)	V _{BE(on)}	—	1.5	1.7	V	I _C = 1A, V _{CE} = 5V	
Output Capacitance (Note 12)	C _{obo}	—	10	15	pF	V _{CB} = 10V, f = 1MHz	
Current Gain-Bandwidth Product (Note 12)	f _T	150	250	—	MHz	V _{CE} = 10V, I _C = 100mA, f = 20MHz	
Turn-On Time	t _{on}	—	0.75	—	μs	V _{CC} = 10V, I _C = 500mA	
Turn-Off Time	t _{off}	—	2.20	—	μs	I _{B1} = -I _{B2} = 0.5mA	

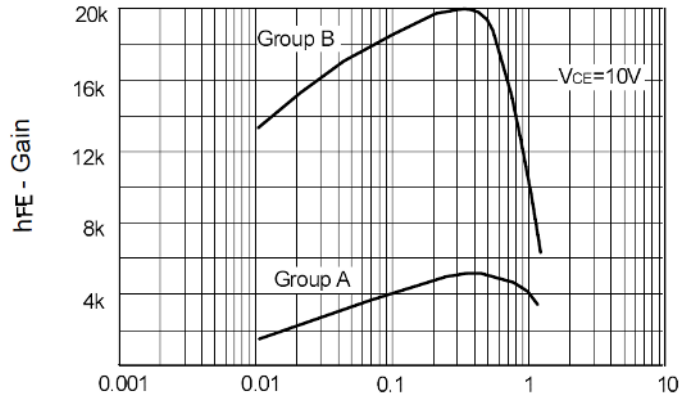
Note: 12. Measured under pulsed conditions. Pulse width ≤ 300 μs. Duty cycle ≤ 2%.

Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)



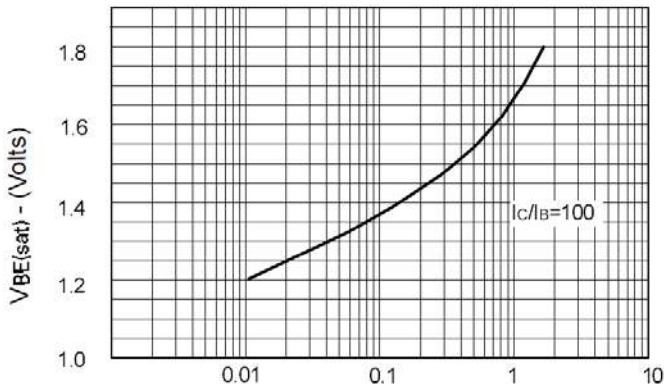
I_C - Collector Current (Amps)

VCE(sat) v IC



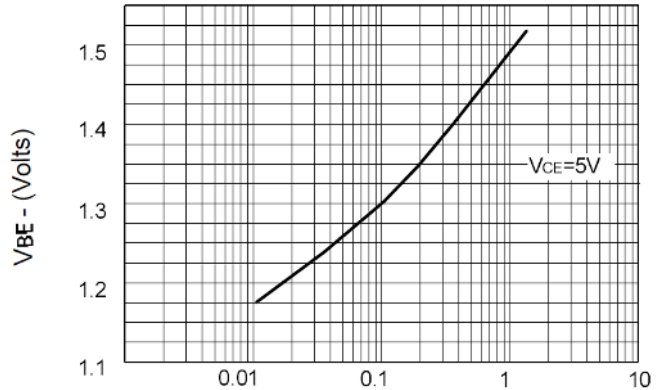
I_C - Collector Current (Amps)

hFE v IC



I_C - Collector Current (Amps)

VBE(sat) v IC



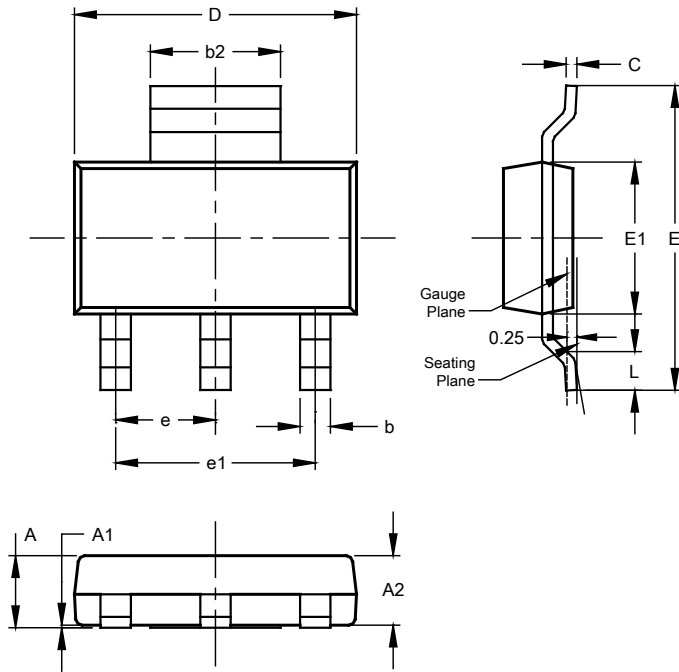
I_C - Collector Current (Amps)

VBE(on) v IC

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT223 (Type DN)

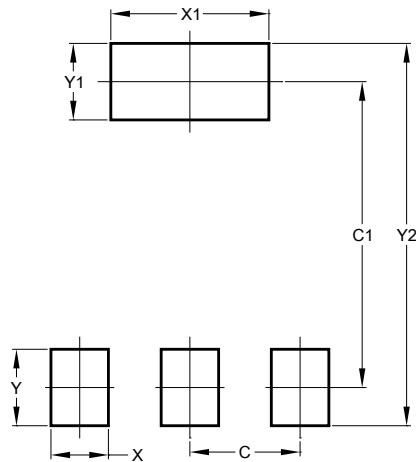


SOT223 (Type DN)			
Dim	Min	Max	Typ
A	—	1.70	—
A1	0.01	0.15	—
A2	1.50	1.68	1.60
b	0.60	0.80	0.70
b2	2.90	3.10	—
c	0.20	0.32	—
D	6.30	6.70	—
E	6.70	7.30	—
E1	3.30	3.70	—
e	—	—	2.30
e1	—	—	4.60
L	0.85	—	—
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT223 (Type DN)



Dimensions	Value (in mm)
C	2.30
C1	6.40
X	1.20
X1	3.30
Y	1.60
Y1	1.60
Y2	8.00

Note: 13. For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device terminals and PCB tracking.

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